# **Fundamentals of Microelectronics**

- CH1 Why Microelectronics?
- CH2 Basic Physics of Semiconductors
- CH3 Diode Circuits
- > CH4 Physics of Bipolar Transistors
- CH5 Bipolar Amplifiers
- CH6 Physics of MOS Transistors
- CH7 CMOS Amplifiers
- CH8 Operational Amplifier As A Black Box

1

# **Chapter 6 Physics of MOS Transistors**

- 6.1 Structure of MOSFET
- 6.2 Operation of MOSFET
- > 6.3 MOS Device Models
- > 6.4 PMOS Transistor
- > 6.5 CMOS Technology
- 6.6 Comparison of Bipolar and CMOS Devices

# **Chapter Outline**

#### Operation of MOSFETs

#### **MOS Device Models**

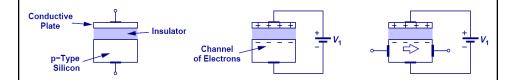
#### **PMOS Devices**

- MOS Structure
- Operation in Triode Region
- Operation in Saturation
- I/V Characteristics
- Large-Signal Model
- Small-Signal Model
- Structure
- Models

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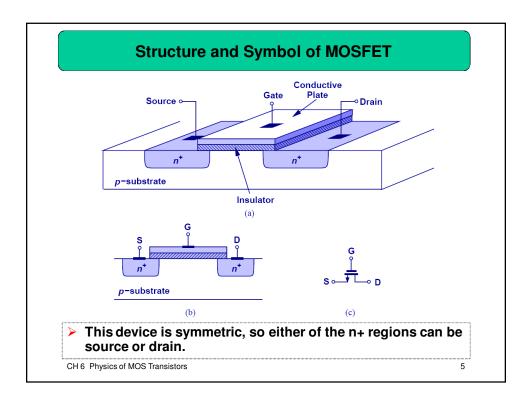
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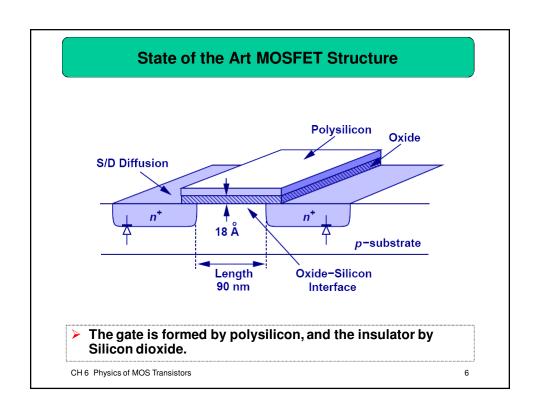
# Metal-Oxide-Semiconductor (MOS) Capacitor

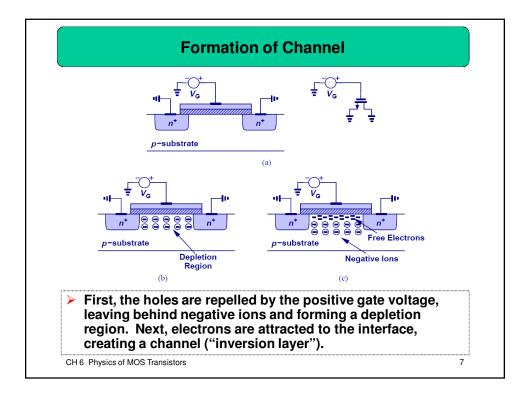


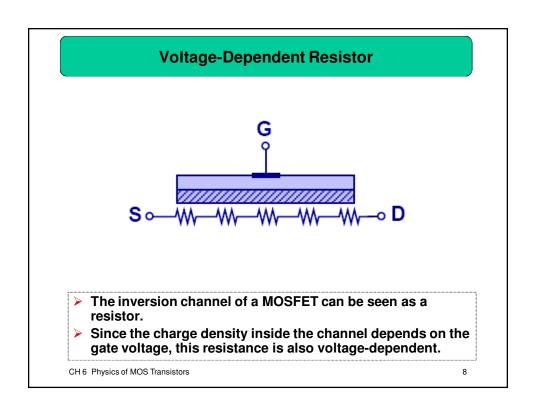
The MOS structure can be thought of as a parallel-plate capacitor, with the top plate being the positive plate, oxide being the dielectric, and Si substrate being the negative plate. (We are assuming P-substrate.)

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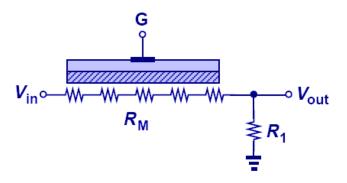








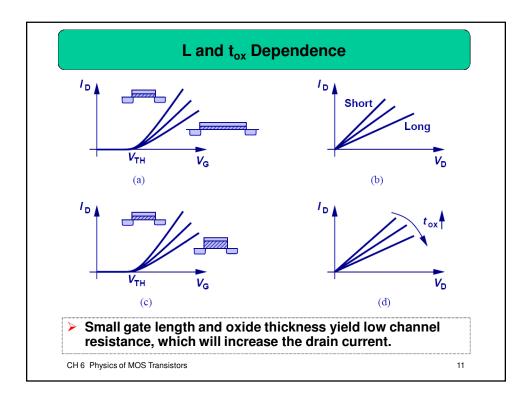
# **Voltage-Controlled Attenuator**

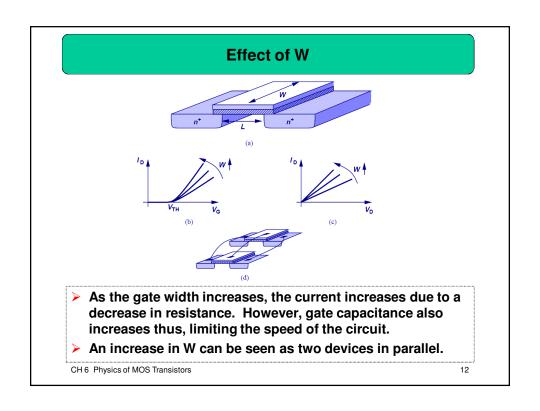


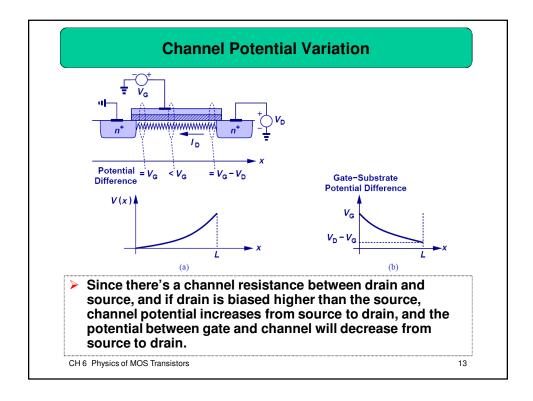
- > As the gate voltage decreases, the output drops because the channel resistance increases.
- This type of gain control finds application in cell phones to avoid saturation near base stations.

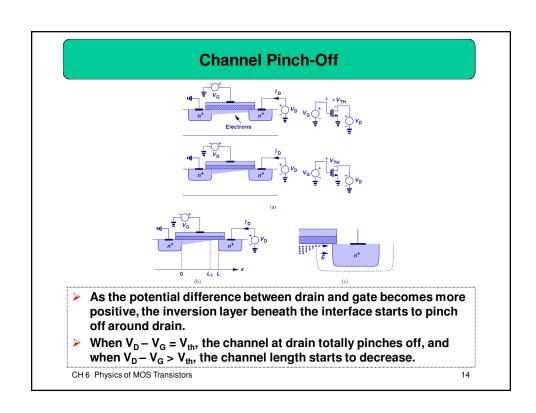
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9

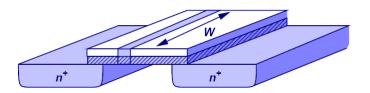








# **Channel Charge Density**



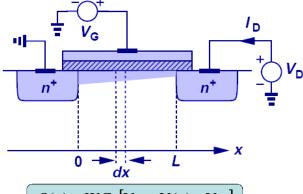
$$Q = WC_{ox}(V_{GS} - V_{TH})$$

➤ The channel charge density is equal to the gate capacitance times the gate voltage in excess of the threshold voltage.

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15

# **Charge Density at a Point**

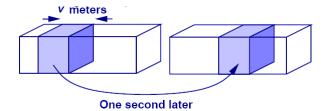


 $Q(x) = WC_{ox}[V_{GS} - V(x) - V_{TH}]$ 

Let x be a point along the channel from source to drain, and V(x) its potential; the expression above gives the charge density (per unit length).

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# **Charge Density and Current**



$$I = Q \cdot v$$

The current that flows from source to drain (electrons) is related to the charge density in the channel by the charge velocity.

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17

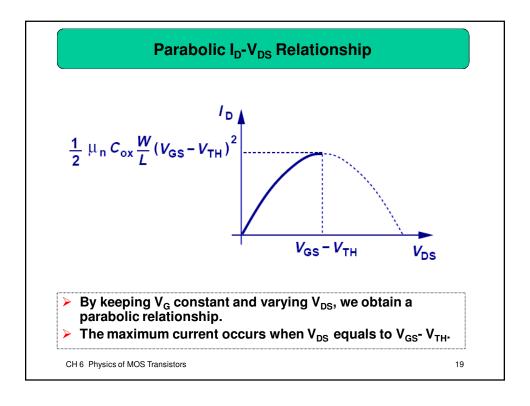
#### **Drain Current**

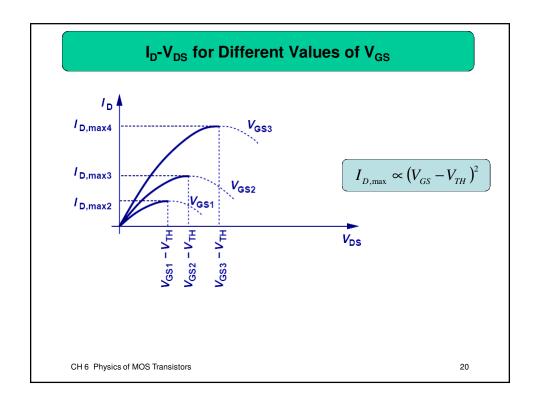
$$v = +\mu_{n} \frac{dV}{dx}$$

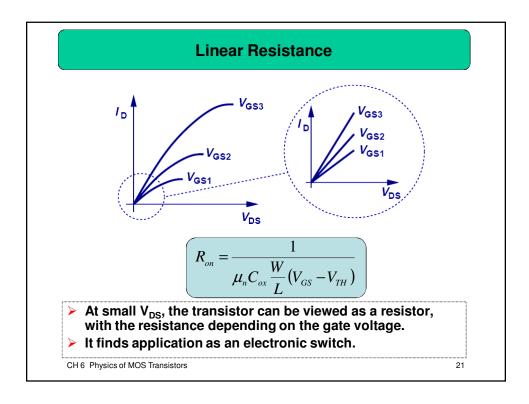
$$I_{D} = WC_{ox}[V_{GS} - V(x) - V_{TH}]\mu_{n} \frac{dV(x)}{dx}$$

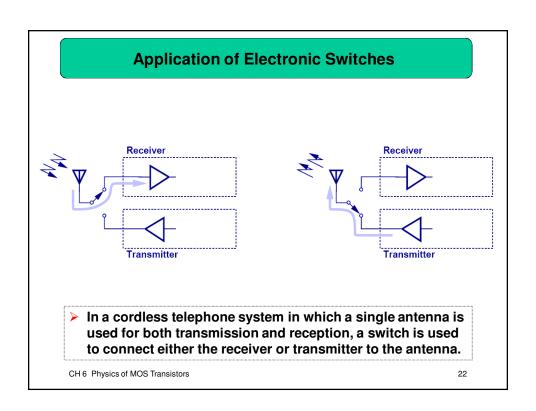
$$I_{D} = \frac{1}{2}\mu_{n}C_{ox} \frac{W}{L}[2(V_{GS} - V_{TH})V_{DS} - V_{DS}^{2}]$$

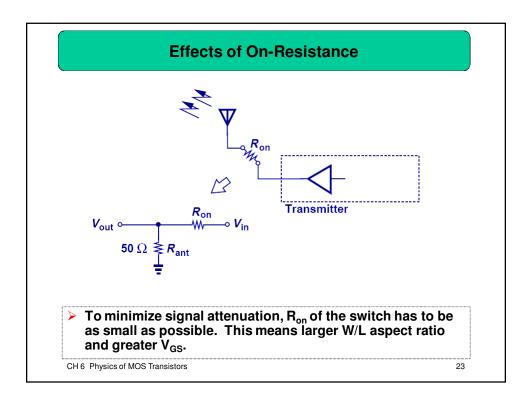
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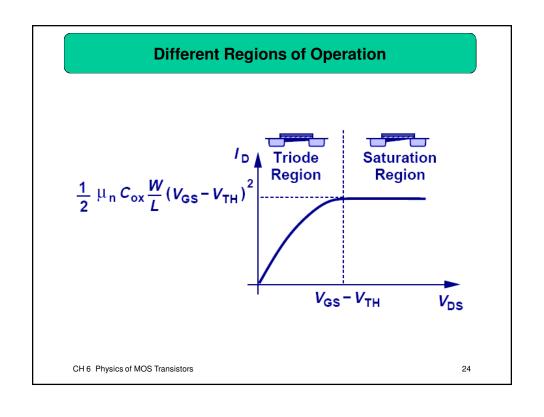




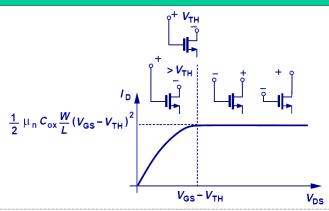








# How to Determine 'Region of Operation'



- When the potential difference between gate and drain is greater than V<sub>TH</sub>, the MOSFET is in triode region.
- When the potential difference between gate and drain becomes equal to or less than V<sub>TH</sub>, the MOSFET enters saturation region.

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25

#### **Triode or Saturation?**

$$V_{DD} = 1.8 \text{ V}$$

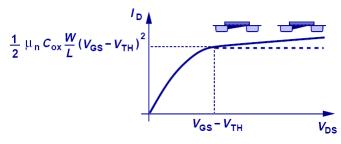
$$R_{D} \ge 5 \text{ k}\Omega$$

$$I_{D} = 1.8 \text{ V}$$

When the region of operation is not known, a region is assumed (with an intelligent guess). Then, the final answer is checked against the assumption.

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# **Channel-Length Modulation**



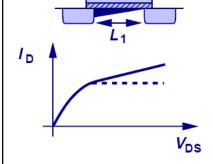
$$I_{D} = \frac{1}{2} \mu_{n} C_{ox} \frac{W}{L} (V_{GS} - V_{TH})^{2} (1 + \lambda V_{DS})$$

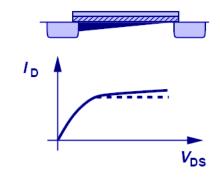
The original observation that the current is constant in the saturation region is not quite correct. The end point of the channel actually moves toward the source as V<sub>D</sub> increases, increasing I<sub>D</sub>. Therefore, the current in the saturation region is a weak function of the drain voltage.

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2

# λ and L





- Unlike the Early voltage in BJT, the channel- length modulation factor can be controlled by the circuit designer.
- For long L, the channel-length modulation effect is less than that of short L.

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W/L Constant V <sub>GS</sub> −V <sub>TH</sub> Variable	W/L Variable V <sub>GS</sub> −V <sub>TH</sub> Constant	$\frac{W}{L}$ Variable $V_{GS} - V_{TH}$ Constant
$egin{aligned} egin{aligned} egin{aligned\\ egin{aligned} egi$	$g_{ m m}^{} \propto I_{ m D}^{}$ $g_{ m m}^{} \propto rac{W}{L}^{}$	$g_{ m m} \propto \sqrt{rac{W}{L}}$ $g_{ m m} \propto rac{1}{V_{ m GS} - V_{ m TH}}$

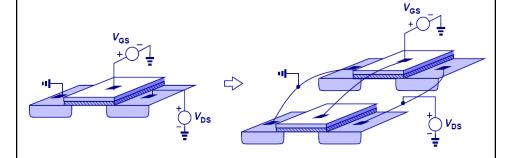
$$g_{m} = \mu_{n} C_{ox} \frac{W}{L} (V_{GS} - V_{TH}) \qquad g_{m} = \sqrt{2\mu_{n} C_{ox} \frac{W}{L} I_{D}} \qquad g_{m} = \frac{2I_{D}}{V_{GS} - V_{TH}}$$

- Transconductance is a measure of how strong the drain current changes when the gate voltage changes.
- > It has three different expressions.

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29

# Doubling of $g_{\rm m}$ Due to Doubling W/L



If W/L is doubled, effectively two equivalent transistors are added in parallel, thus doubling the current (if V<sub>GS</sub>-V<sub>TH</sub> is constant) and hence g<sub>m</sub>.

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# **Velocity Saturation**

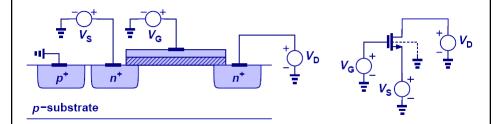
$$\begin{pmatrix}
I_D = V_{sat} \cdot Q = V_{sat} \cdot WC_{ox} (V_{GS} - V_{TH}) \\
g_m = \frac{\partial I_D}{\partial V_{GS}} = V_{sat} WC_{ox}
\end{pmatrix}$$

- Since the channel is very short, it does not take a very large drain voltage to velocity saturate the charge particles.
- In velocity saturation, the drain current becomes a linear function of gate voltage, and gm becomes a function of W.

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3

# **Body Effect**



$$V_{TH} = V_{TH \ 0} + \rho \left( \sqrt{2\phi_F + V_{SB}} - \sqrt{2\phi_F} \right)$$

As the source potential departs from the bulk potential, the threshold voltage changes.

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# **Large-Signal Models**

 $V_{\rm GS} > V_{\rm TH}$ 

$$V_{DS} > V_{GS} - V_{TH}$$

$$G \circ \frac{1}{2} \mu_{n} C_{ox} \frac{W}{L} (V_{GS} - V_{TH})^{2} (1 + \lambda V_{DS})$$

$$V_{GS} > V_{TH}$$

$$V_{DS} < V_{GS} - V_{TH}$$

$$V_{DS} < V_{GS} - V_{TH}$$

$$V_{DS} < 2 (V_{GS} - V_{TH})$$

$$G \circ \frac{1}{2} \mu_{n} C_{ox} \frac{W}{L} [2 (V_{GS} - V_{TH}) V_{DS} + V_{DS}^{2}]$$

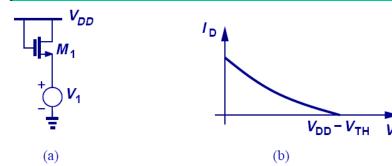
$$G \circ \frac{1}{2} \mu_{n} C_{ox} \frac{W}{L} [V_{GS} - V_{TH}) V_{DS} + V_{DS}^{2}]$$

Based on the value of V<sub>DS</sub>, MOSFET can be represented with different large-signal models.

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33

# Example: Behavior of I<sub>D</sub> with V<sub>1</sub> as a Function

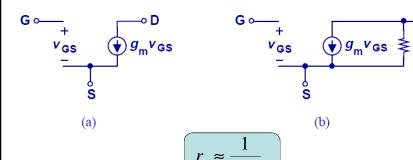


$$I_{D} = \frac{1}{2} \mu_{n} C_{ox} \frac{W}{L} (V_{DD} - V_{1} - V_{TH})^{2}$$

Since V<sub>1</sub> is connected at the source, as it increases, the current drops.

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# **Small-Signal Model**

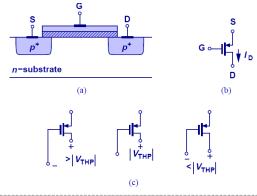


- When the bias point is not perturbed significantly, small-signal model can be used to facilitate calculations.
- > To represent channel-length modulation, an output resistance is inserted into the model.

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35

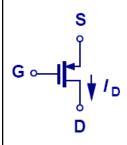
#### **PMOS Transistor**



- Just like the PNP transistor in bipolar technology, it is possible to create a MOS device where holes are the dominant carriers. It is called the PMOS transistor.
- It behaves like an NMOS device with all the polarities reversed.

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# **PMOS Equations**

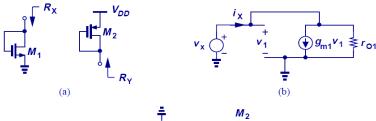


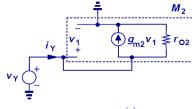
$$\begin{split} I_{D,sat} &= \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (V_{GS} - V_{TH})^2 (1 - \lambda V_{DS}) \\ I_{D,tri} &= \frac{1}{2} \mu_p C_{ox} \frac{W}{L} [2(V_{GS} - V_{TH}) V_{DS} - V_{DS}^2] \\ I_{D,sat} &= \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (|V_{GS}| - |V_{TH}|)^2 (1 + \lambda |V_{DS}|) \\ I_{D,tri} &= \frac{1}{2} \mu_p C_{ox} \frac{W}{L} [2(|V_{GS}| - |V_{TH}|) V_{DS} | - V_{DS}^2] \end{split}$$

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3

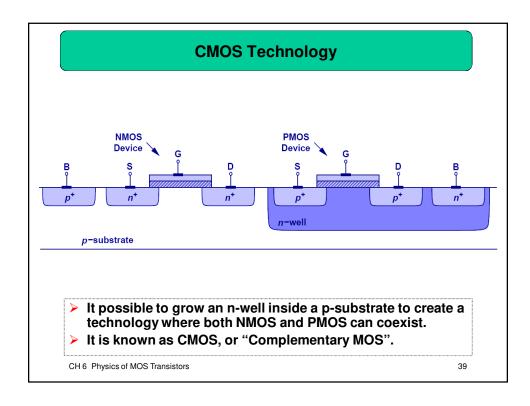
# **Small-Signal Model of PMOS Device**





The small-signal model of PMOS device is identical to that of NMOS transistor; therefore,  $R_{\chi}$  equals  $R_{\gamma}$  and hence  $(1/gm)||r_{o}$ .

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# Bipolar TransistorMOSFETExponential Characteristic<br/>Active: $V_{CB} > 0$ <br/>Saturation: $V_{CB} < 0$ <br/>Finite Base Current<br/>Early Effect<br/>Diffusion CurrentQuadratic Characteristic<br/>Saturation: $V_{DS} > V_{GS} - V_{TH}$ <br/>Triode: $V_{DS} < V_{GS} - V_{TH}$ <br/>Zero Gate Current<br/>Channel-Length Modulation<br/>Drift Current

Voltage-Dependent Resistor

**Comparison of Bipolar and MOS Transistors** 

Bipolar devices have a higher g<sub>m</sub> than MOSFETs for a given bias current due to its exponential IV characteristics.

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